

Application note

Seamless supply switchover for sleep modes.

AN-PM-019

Abstract

An investigation into a seamless switch of input supply to support a low power sleep state when using the Dialog DA9021, DA9022, DA9052, DA9053 or DA9057 PMIC.

Seamless supply switchover for sleep modes.

Contents

Abstract 1

Contents 2

Figures..... 2

1 Terms and definitions 2

2 References 2

3 Introduction..... 3

4 Evaluation setup description 3

5 DCIN to VBUS switchover evaluation 3

6 DCIN to VBAT seamless switchover 7

7 Energy efficiency..... 9

8 Conclusion 9

Revision history..... 10

Figures

Figure 1 Disable DCIN supply 3

Figure 2 No load on VBUCKCORE 4

Figure 3 A 30 mA load is added on VBUCKCORE 100 µF capacitor on VDDOUT 4

Figure 4 Switchover showing LX node 5

Figure 5 Switchover by DCIN_SUSP bit in R67 6

Figure 6 Supply sleep current via diode onto VBAT. 7

Figure 7 Supply via single diode to provide 4.3V on VBAT 8

1 Terms and definitions

DA905x	For this document this will be used to represent DA9021, DA9022, DA9052, DA9053 and DA9057
PFM	Pulse Frequency Modulation
PWM	Pulse Width Modulation

2 References

[1] DA9053-00-IDS3a_140114.pdf, Datasheet, Dialog Semiconductor

Seamless supply switchover for sleep modes.

3 Introduction

It is a requirement for some applications to be able to switch input supply when the system enters a sleep state. This application note investigates the options for having a seamless switchover from DCIN as the main supply to VBUS as a “sleep” supply in systems using the DA9053 with no battery. A seamless switch from either DCIN or VBUS to VBAT is also investigated. The findings are applicable to devices from the DA905x family of PMIC’s from Dialog Semiconductor.

4 Evaluation setup description

- A 3F programmed DA9053 part on 11x11 Eval board 44-179-115-03-B
- VBUS supplied by a Hameg HM8143 with the output set to 5 V @ 68 mA current limit.
- DCIN supplied by a TTI PL155 with the output set to 5 V @ 500 mA current limit.
- 50 mA load on VBUCKCORE provided by Hameg CH2 which gives a load on DCIN of 19 mA.

5 DCIN to VBUS switchover evaluation

This section investigates the possibility of implementing a seamless switchover from DCIN to VBUS with a 20 mA load on the supply (DCIN/VBUS).



Figure 1 Disable DCIN supply

Figure 1 shows VDDOUT (yellow trace) dropping below the VDDFAULT threshold during the switchover from DCIN (pink trace) to VBUS(cyan trace). The result of this would be a reset of the system with a loss of all state information. The green trace shows the nVDDFAULT signal.

Seamless supply switchover for sleep modes.

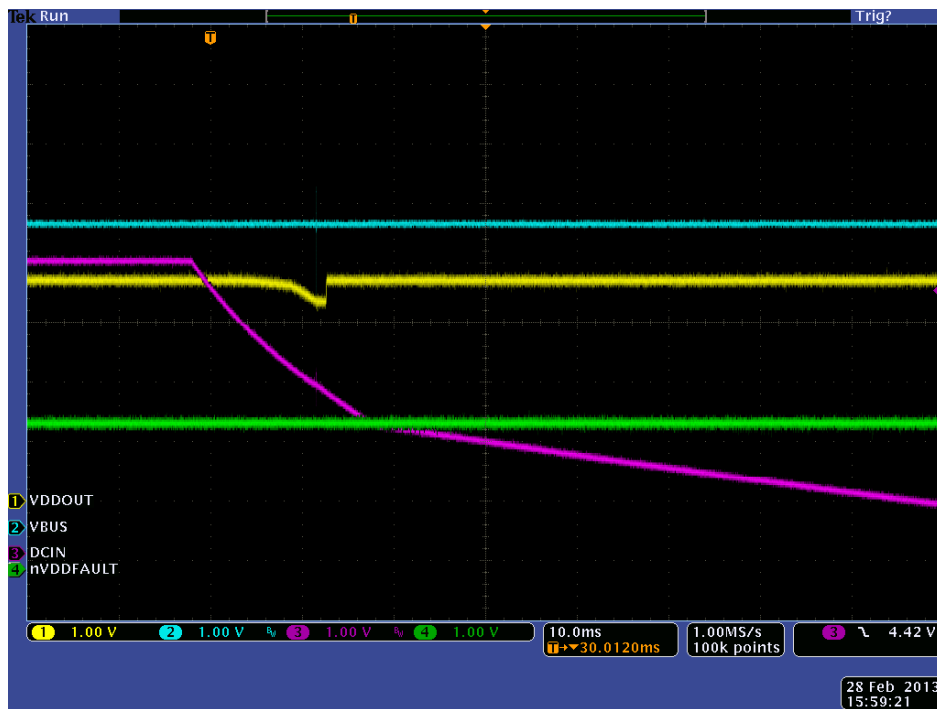


Figure 2 No load on VBUCKCORE

Figure 2 shows the behaviour when the load on VBUCKCORE is reduced to 0 mA. The result of this would be that the system does not reset and stays in the Active state. The green trace shows the nVDDFAULT signal.

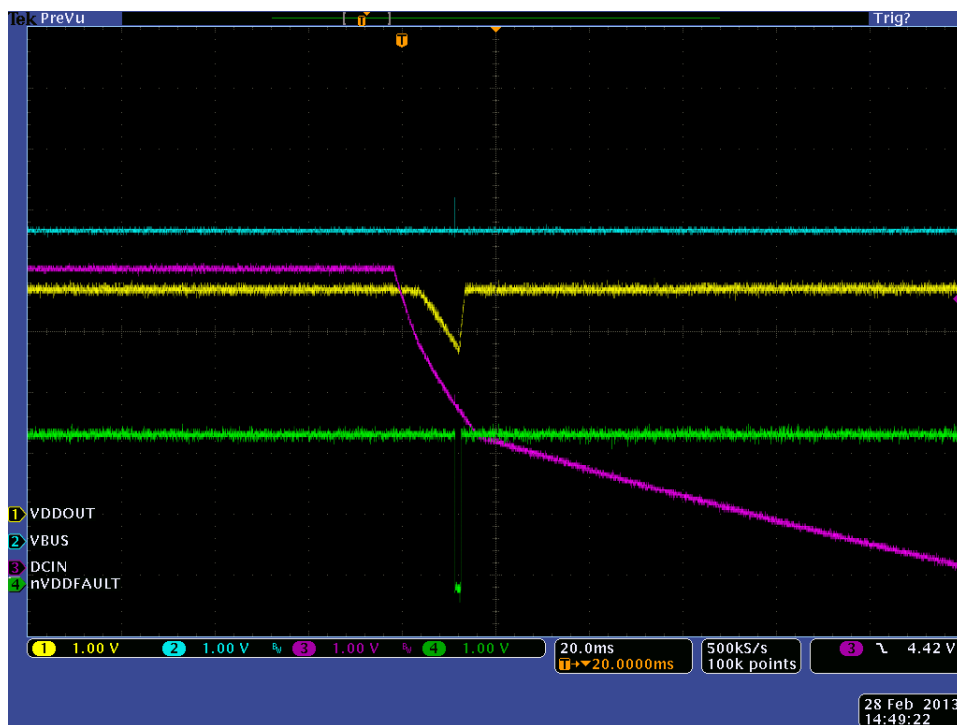


Figure 3 A 30 mA load is added on VBUCKCORE, 100 μ F capacitor on VDDOUT

Seamless supply switchover for sleep modes.

Adding additional capacitance to VDDOUT can help maintain VDDOUT during the switchover. [Figure 3](#) shows that nVDDFAULT is still triggered with a 30 mA load on VBUCKCORE, even though 100 μ F of additional capacitance has been added to VDDOUT. VBUCKCORE is set to 1.25 V.

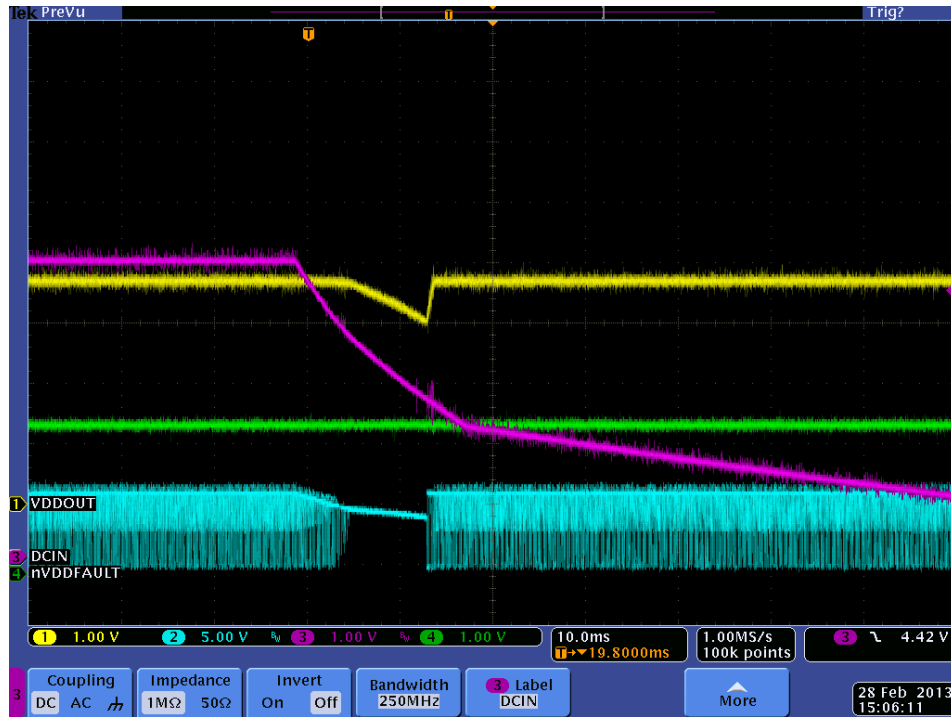


Figure 4 Switchover showing LX node

[Figure 4](#) shows that the charger buck stops switching as the voltage on DCIN drops. Following this there is a period of 10 ms while VBUS is detected and validated before the buck starts to switch again. It is this period which is the reason for the droop seen on VDDOUT.

Seamless supply switchover for sleep modes.

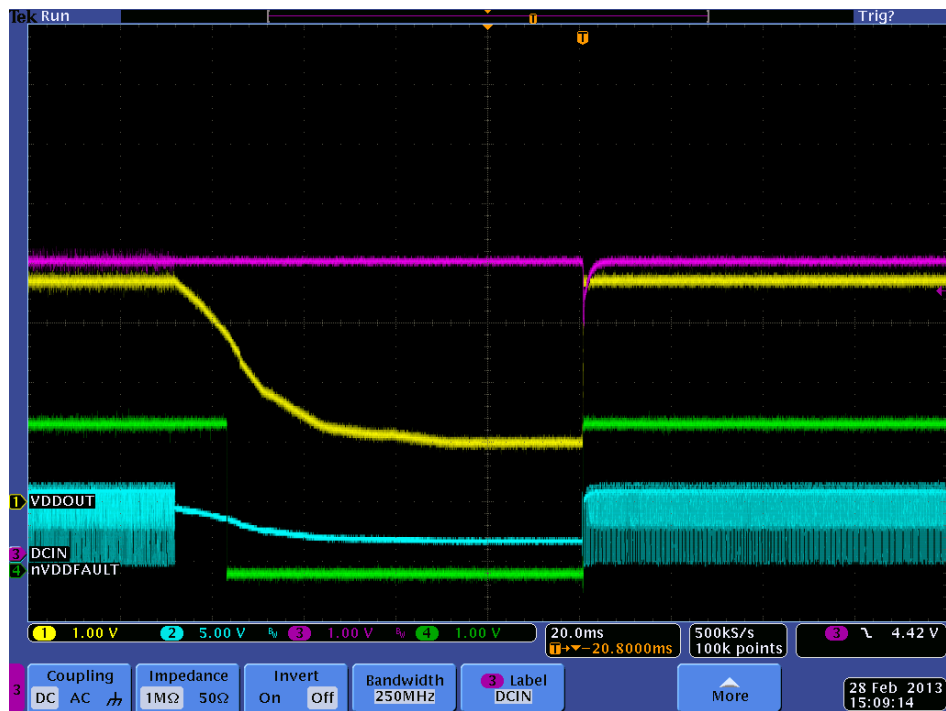


Figure 5 Switchover by DCIN_SUSP bit in R67

To investigate alternative options for triggering the switchover, the DCIN input was disabled by setting the DCIN_SUSP bit in R67. As it can be seen from [Figure 5](#), this resulted in a longer switchover period and does not enable a seamless switchover.

Seamless supply switchover for sleep modes.

6 DCIN to VBAT seamless switchover

An alternative to switching between DCIN and VBUS is to switch between either DCIN or VBUS and VBAT. In this case it is preferable to reduce the voltage being applied to the VBAT input below the 5 V that would be used for either DCIN or VBUS.

In most cases the sleep supply will be provided by a low power efficient regulator, however in systems where the sleep supply is already configured for 5 V it should be acceptable to use one or two series diodes to drop the 5 V to either 4.3 or 3.6V. As the current consumption should be low in the sleep state, the impact in the overall efficiency when using the diodes should be acceptable.



Figure 6 Supply sleep current via diode onto VBAT.

Figure 6 shows the switching behaviour if the Sleep current is provided via a diode onto VBAT. Attaching the sleep supply to VBAT is the safest option as it will avoid any possibility of overdriving VDDOUT which may cause instabilities with the charger buck. The voltage on VBAT is 3.6 V, which is two diode drops below the 5 V supply.

Seamless supply switchover for sleep modes.



Figure 7 Supply via single diode to provide 4.3V on VBAT

Figure 7 shows the same behaviour but this time the voltage supplied to VBAT is 4.3 V, which is a single diode drop from the 5 V supply. During the period that both DCIN and VBUS are present, the charger buck will regulate to 250 mV above VBAT, so approximately 4.6 V.

Seamless supply switchover for sleep modes.

7 Energy efficiency

The goal of implementing a sleep mode in any system is to minimise the energy consumption when the system is not required to be active. In the following discussion, it is assumed that the target is to consume less than 100 mW from the 5 V sleep supply. This translates to a target current of 20 mA.

If the system is to use the charger buck to provide the system current in sleep then the buck will be running and consuming its quiescent current. Although the charger buck does support a PFM low power mode, it does not support automatic mode switching. This causes a problem in that the host processor would have to be operating to perform the I2C write to set the buck into PFM mode. To achieve this, the host would have to be consuming less than 100 mA. This is likely to be difficult to achieve. The wake-up procedure would also have to be carefully managed so that the current did not exceed 100 mA until the buck was back in PWM mode. Assuming that this mode transition is not possible, the buck will only operate in PWM mode.

In PWM mode the buck has a quiescent current of around 6 mA. So, with a 5 V input voltage, the buck will consume approximately 30 mW.

In the system with two diodes, there will be a voltage drop of approximately 1.4 V across the diodes. With the maximum 20 mA flowing there will be 28 mW dissipated in the diodes.

In the case of the single diode the dissipation in the diodes will be reduced to 14 mW.

If we compare the option with the two diodes to the option using the charger buck there is little difference. The option with the single diode may be more efficient.

8 Conclusion

From the above measurements it can be concluded that it is not possible to have a seamless switchover from DCIN to VBUS without a battery connected to the system. The recommended solution when a system calls for a switch over to a sleep supply is to connect the main 5 V supply to DCIN(or VBUS), while the 5 V sleep supply should be connected via a diode to VBAT (~4.3 V on VBAT).

Seamless supply switchover for sleep modes.

Revision history

Revision	Date	Description
1.0	04-Mar-2013	Initial version.
1.1	20-Jul-2015	Updated to new template.
1.2	17-Nov-2015	Minor update of wording. Changed filename to make clearer
1.3	18-Nov-2015	Added other relevant Dialog devices to Abstract.

Seamless supply switchover for sleep modes.

Status definitions

Status	Definition
DRAFT	The content of this document is under review and subject to formal approval, which may result in modifications or additions.
APPROVED or unmarked	The content of this document has been approved for publication.

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Contacting Dialog Semiconductor

United Kingdom (Headquarters)

Dialog Semiconductor (UK) LTD
Phone: +44 1793 757700

Germany

Dialog Semiconductor GmbH
Phone: +49 7021 805-0

The Netherlands

Dialog Semiconductor B.V.
Phone: +31 73 640 8822

Email:

enquiry@diasemi.com

North America

Dialog Semiconductor Inc.
Phone: +1 408 845 8500

Japan

Dialog Semiconductor K. K.
Phone: +81 3 5425 4567

Taiwan

Dialog Semiconductor Taiwan
Phone: +886 281 786 222

Web site:

www.dialog-semiconductor.com

Singapore

Dialog Semiconductor Singapore
Phone: +65 64 8499 29

Hong Kong

Dialog Semiconductor Hong Kong
Phone: +852 3769 5200

Korea

Dialog Semiconductor Korea
Phone: +82 2 3469 8200

China (Shenzhen)

Dialog Semiconductor China
Phone: +86 755 2981 3669

China (Shanghai)

Dialog Semiconductor China
Phone: +86 21 5424 9058